TAIYO AMERICA, INC.

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CERTIFICATE OF CONFORMANCE

This is to certify that the following product has been inspected prior to sale and shipment, and complies with Taiyo America's manufacturing specifications for this product. This product meets the requirements of IPC-4781 and the performance requirements of A-A-56032D, Type II-YEL, as it applies to printed circuit boards applications.

PSR-4100 YL (HD) 70/30

Lot # 0021017

Mfg. Date: 2-10 - 20

Warranty Ends: 11-10-20

		MANUFACTURING		
PROPERTY	TEST METHOD	<u>SPECIFICATION</u>	RESU	TT T
VISCOSITY	Toki Sangyo RE100U Viscometer	Before mixing: Report Only		ps
	5 rpms @ 25°C	After mixing: 120 - 160 ps	132	•
THE OTHER DESIGNATION OF THE OTHER DESIGNATION	5 i pins & 25 C	Arter mixing. 120 - 100 ps	152	рs
THIXOTROPIC INDEX	Toki Sangyo RE100U Viscometer Viscosity ratio: 5 rpm / 50 rpm	After mixing: 1.2 - 1.6	1.3	
FINENESS OF GRIND	TAI-0-0002	15 microns maximum	5	microns
VISUAL EXAMINATION	Microscopic examination:			
	1. 1-mil drawdown of wet film	No bubbles, pits, voids, particles, color differences.	Passed	
	2. Wet film drawdown on grind gauge	No bubbles, pits, voids, particles, color differences.	Passed	
SCREENABILITY	Visual inspection of screen printed panel	No surface defects, such as bubbles, pinholes, etc.	Passed	U
TACK-DRY	Hot air convection oven 90°C/30 minutes	Tack-free to the touch	Passed	
IMAGING		0	2	
MAGING	ORC HMW 680GW - 7 kW 500 mJ / cm ²	Stouffer 21 step: 8 - 10 (clear on copper)	Ö	
	Horizontal Developer - 1% Na2CO3	(clear on copper)		
	30°C (86°F) / 60 secs., 28 psi	ia.		
RESISTANCE TO	260°C (500°F) / 10 sec x 3 cycles	No dissolvention maline	Passed	
SOLDERING (*)	Rosin-based flux	No discoloration, peeling, or blistering	1 asseu	9
		or bustering		
SOLVENT DESIGNANCE (*)	Immersion in PM Acetate	No swelling, softening,	Passed	V
RESISTANCE (*)	20° C / 30 mins.	or blistering	0.11	
PENCIL HARDNESS (*)	TAI-0-0020	7H or greater	814	
ADHESION (*)	TAI-0-0021	100/100 on copper	Passed	

(*) - Final cure for these tests was 60 minutes @ 150°C (302°F) in a convection oven

Q.C. Supervisor 2/24/20
Title, Date